

| L Number | Hits | Search Text | DB | Time stamp |
|----------|-------|--|---|------------------|
| 262 | 14 | "5945736" | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 13:15 |
| 263 | 37 | "5397919" | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 13:17 |
| 264 | 11 | "5579827" | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 13:17 |
| 265 | 47 | "5313099" | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 13:18 |
| 266 | 46 | "5329426" | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 13:22 |
| 267 | 4 | "6166435" | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 13:23 |
| 268 | 114 | "5945736" "5397919" "5579827" "5313099" "5329426" "6166435" | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 13:23 |
| 269 | 23 | ("2432513" "2916159" "2958515" "3033537" "3146384" "3182114" "3229756" "3417300" "4481525" "4576224" "4607685" "4745456" "4753287" "4924352" "5170323" "5313099" "5945736" "6014315" "6021045" "6075699" "6093961" "6116120" "6236569").PN. | USPAT | 2003/01/25 13:26 |
| 282 | 2 | 6166435.URPN. | USPAT | 2003/01/25 13:29 |
| 283 | 3 | ("5153379" "5917702" "5977626").PN. | USPAT | 2003/01/25 13:29 |
| 284 | 3 | 5885848.URPN. | USPAT | 2003/01/25 13:32 |
| 285 | 19 | ("4612978" "4748495" "4884169" "5227663" "5285352" "5293930" "5311060" "5355283" "5386342" "5397919" "5451274" "5467253" "5525835" "5528159" "5555488" "5610442" "5619070" "5620928" "5672547").PN. | USPAT | 2003/01/25 13:32 |
| 286 | 23578 | semiconductor near1 (housing package) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 13:59 |
| 287 | 24642 | (cap lid (heat adj sink)) near3 (rotated rotating slided sliding slide) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 14:02 |
| 288 | 40 | (semiconductor near1 (housing package)) and ((cap lid (heat adj sink)) near3 (rotated rotating slided sliding slide)) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 14:02 |
| 289 | 10 | 5571027.URPN. | USPAT | 2003/01/25 14:08 |
| 290 | 6 | ("4684184" "4832612" "4846703" "5127837" "5180976" "5397245").PN. | USPAT | 2003/01/25 14:10 |
| 291 | 32 | 4832612.URPN. | USPAT | 2003/01/25 14:13 |
| 292 | 0 | 6338409.URPN. | USPAT | 2003/01/25 14:15 |
| 293 | 8 | ("4706161" "4757355" "4832612" "5314068" "5482161" "5713711" "5740845" "5896729").PN. | USPAT | 2003/01/25 14:16 |
| 294 | 2 | 5938454.URPN. | USPAT | 2003/01/25 14:18 |

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|-----|----|---|----------------|------------------|
| 295 | 11 | ("4063791" "4597617" "4832612" "5059129" "5068601" "5137461" "5185073" "5321583" "5468158" "5691041" "5793618").PN. | USPAT | 2003/01/25 14:19 |
| 296 | 7 | 5919050.URPN. | USPAT | 2003/01/25 14:21 |
| 297 | 13 | ("Re30604" "4007479" "4351580" "4354720" "4390220" "4513353" "4535887" "4547794" "4564880" "4575747" "4597617" "4696526" "4725922").PN. | USPAT USPAT | 2003/01/25 14:22 |
| 298 | 6 | ("4684184" "4832612" "4846703" "5127837" "5180976" "5397245").PN. | USPAT | 2003/01/25 14:23 |

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|----------|--------|---|---|------------------|
| 317 | 1388 | 257/704 | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 14:53 |
| 318 | 11920 | ((cap lid (heat adj sink)) near2 (rotated rotating)) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 15:18 |
| 319 | 2 | 257/704 and ((cap lid (heat adj sink)) near2 (rotated rotating)) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 14:58 |
| 320 | 0 | 6020632.URPN. | USPAT | 2003/01/25 14:57 |
| 321 | 10 | ("3855606" "4054814" "4281993" "4878107" "5068866" "5296724" "5340993" "5808325" "5825054" "5878069").PN. | USPAT | 2003/01/25 14:57 |
| 322 | 880 | ((cap lid (heat adj sink)) near2 (rotated rotating)) and (chip semiconductor die) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 15:02 |
| 323 | 164359 | (base substrate) near3 (housing cavity opening) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 15:01 |
| 324 | 187 | ((cap lid (heat adj sink)) near2 (rotated rotating)) and (chip semiconductor die)) and ((base substrate) near3 (housing cavity opening)) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 15:01 |
| 325 | 10946 | ((base substrate) near3 (housing cavity opening)) with (chip semiconductor die) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 15:02 |
| 326 | 30 | ((cap lid (heat adj sink)) near2 (rotated rotating)) and ((base substrate) near3 (housing cavity opening)) with (chip semiconductor die)) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 15:20 |
| 327 | 2 | 6049215.URPN. | USPAT | 2003/01/25 15:06 |
| 328 | 29 | ("3766439" "4169642" "4341842" "4386815" "4427249" "4567432" "4597617" "4679118" "4684184" "4750890" "4789345" "4812191" "4832612" "4846703" "4846704" "4859189" "4883428" "4922376" "5006792" "5066357" "5073117" "5123850" "5127837" "5180976" "5225037" "5302891" "5397245" "5402077" "5468157").PN. | USPAT | 2003/01/25 15:07 |
| 329 | 31 | 5402077.URPN. | USPAT | 2003/01/25 15:08 |
| 330 | 1 | 5132535.URPN. | USPAT | 2003/01/25 15:17 |
| 331 | 6 | ("3655975" "3665194" "4518860" "4704537" "4920272" "4992658").PN. | USPAT | 2003/01/25 15:17 |
| 332 | 13050 | (cap lid (heat adj sink)) near2 (rotated rotating twisting twisted) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 15:19 |
| 333 | 1130 | ((cap lid (heat adj sink)) near2 (rotated rotating twisting twisted)) not ((cap lid (heat adj sink)) near2 (rotated rotating)) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 15:20 |
| 334 | 1 | ((cap lid (heat adj sink)) near2 (rotated rotating twisting twisted)) not ((cap lid (heat adj sink)) near2 (rotated rotating)) and ((base substrate) near3 (housing cavity opening)) with (chip semiconductor die)) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 15:20 |
| 335 | 31 | ((cap lid (heat adj sink)) near2 (rotated rotating twisting twisted)) and ((base substrate) near3 (housing cavity opening)) with (chip semiconductor die)) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/01/25 15:20 |